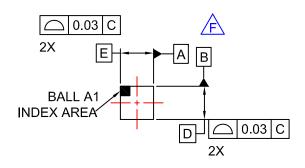


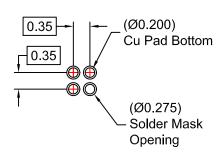
WLCSP4 0.65x0.65x0.298

CASE 567QC ISSUE O

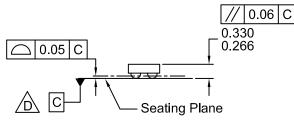
DATE 31 OCT 2016



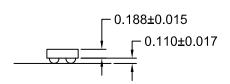
TOP VIEW

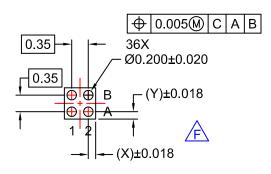


RECOMMENDED LAND PATTERN (NSMD TYPE)



SIDE VIEWS





BOTTOM VIEW

NOTES

- A. NO JEDEC REGISTRATION APPLIES.
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCE PER A SME Y14.5M, 2009.

D DATUM C IS DEFINED BY THE SPHERICAL CROWNS OF THE BALLS.

E. PACKAGE NOMINAL HEIGHT IS

298 ± 32 MICRONS (266-330 MICRONS).

SFOR DIMENSIONS D,E,X, AND Y SEE PRODUCT DATASHEET.

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DESCRIPTION:	WLCSP4 0.65x0.65x0.298		PAGE 1 OF 1

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